

Customer Notification of Product - / Process Change



Vincotech

☒ **PRODUCT-** / ☐ **PROCESS CHANGE**

(According to JEDEC Standard J-STD-046 July 2016)

Vincotech – PCN – No 32-2020

SUBJECT OF CHANGE:	4" -> 6" wafer size change of Rohm SiC Mosfet.
PRODUCTS AFFECTED:	10-PZ126PA080MR-M909F28Y
REASON OF CHANGE:	Improving the supply chain

CLASSIFICATION OF CHANGE: Minor

DESCRIPTION OF CHANGE:

	CURRENT	NEW
wafer size change of Rohm SiC mosfet	Wafer size 4"	Wafer size 6" (thicker backside Ni metallization)

ANTICIPATED IMPACT ON:

Form:	No
Fit:	No
Function:	No
Others:	No

TIME SCHEDULE:

Final qualification report:	on request
First samples available:	on request
Start of delivery:	01/09/2020

PRODUCT IDENTIFICATION:

Part#	Old Revision	New Revision
10-PZ126PA080MR-M909F28Y	n	n+1

DOCUMENTATION

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Important information for your attention:

Minor change:

- For information purpose only (no customer acknowledgment required)

Major change:

- Customers should acknowledge receipt of the PCN within 30 days of delivery of the PCN.
- Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.
- After acknowledgement, lack of additional response within the 90 day period constitutes acceptance of the change.

Vincotech Contact:

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